

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chih-Hsien Chiu</td> <td>08/30/2011</td> </tr> <tr> <td>Tsung-Hsien Tsai</td> <td>08/30/2011</td> </tr> <tr> <td>Chao-Ya Yang</td> <td>08/30/2011</td> </tr> </tbody> </table>		Name	Execution Date	Chih-Hsien Chiu	08/30/2011	Tsung-Hsien Tsai	08/30/2011	Chao-Ya Yang	08/30/2011
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Chih-Hsien Chiu	08/30/2011								
Tsung-Hsien Tsai	08/30/2011								
Chao-Ya Yang	08/30/2011								
RECEIVING PARTY DATA									
Name:	Siliconware Precision Industries Co., Ltd.								
Street Address:	No. 123, Sec. 3, Da Fong Road, Tantz								
City:	Taichung								
State/Country:	TAIWAN								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13566296</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13566296				
Property Type	Number								
Application Number:	13566296								
CORRESPONDENCE DATA									
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>									
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NAME OF SUBMITTER:	Peter F. Corless								
Total Attachments: 1 source=91189_Assignment#page1.tif									

CH \$40.00 13566296

# ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) 1. Chih-Hsien CHIU 2. Tsung-Hsien TSAI  
Full Name(s) 3. Chao-Ya YANG

Hereby sell, assign and transfer to

Assignee SILICONWARE PRECISION INDUSTRIES CO., LTD.  
Name and Address No. 123, Sec. 3, Da Fong Road, Tantzui,  
Taichung, Taiwan, R.O.C.

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

**Title of Invention: PACKAGING STRUCTURE AND METHOD OF FABRICATING THE SAME**

Which application was

Complete either a) executed by the undersigned on \_\_\_\_\_  
b) filed on the \_\_\_\_\_  
Serial No. \_\_\_\_\_

Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date Signed at TAIWAN, R.O.C.  
On August 30, 2011

Inventor(s) CHIH-HSIEN CHIU Chih-Hsien CHIU  
Full Signature(s) Tsung-Hsien TSAI Tsung-Hsien TSAI  
Chao-Ya Yang Chao-Ya YANG